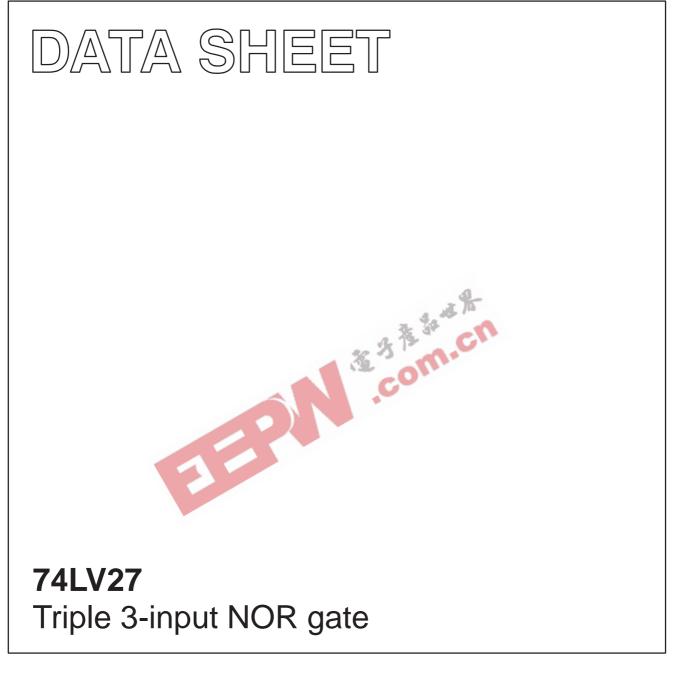
INTEGRATED CIRCUITS



Product specification Supersedes data of 1997 Feb 03 IC24 Data Handbook 1998 Apr 20



74LV27

FEATURES

- Wide operating voltage: 1.0 to 5.5 V
- Optimized for Low Voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between V_{CC} = 2.7 V and V_{CC} = 3.6 V
- Typical V_{OLP} (output ground bounce) < 0.8 V at V_{CC} = 3.3 V, $T_{amb} = 25^{\circ}C.$
- Typical V_{OHV} (output V_{OH} undershoot) > 2 V at V_{CC} = 3.3 V, $T_{amb} = 25^{\circ}C.$
- Output capability: standard
- I_{CC} category: SSI

QUICK REFERENCE DATA

GND = 0 V; $T_{amb} = 25^{\circ}C$; $t_r = t_f \le 2.5$ ns

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT					
t _{PHL} /t _{PLH}	Propagation delay nA, nB, nC to nY	$C_L = 15 \text{ pF};$ $V_{CC} = 3.3 \text{ V}$	8	ns					
Cl	Input capacitance	27 . 0	3.5	pF					
C _{PD}	Power dissipation capacitance per gate	See Notes 1 and 2	24	pF					
DTES: CPD is used to determine the dynamic power dissipation (P _D in μ W) P _D = CP _D × V _{CC} ² × f _i + \sum (C _L × V _{CC} ² × f _o) where:									

DESCRIPTION

function compatible with 74HC/HCT27.

The 74LV27 provides the 3-input NOR function.

The 74LV27 is a low-voltage Si-gate CMOS device and is pin and

NOTES:

- 1. C_{PD} is used to determine the dynamic power dissipation (P_D in μ W) P_D = C_{PD} × V_{CC}² × f_i + \sum (C_L × V_{CC}² × f_o) where: f_i = input frequency in MHz; C_L = output load capacitance in pF; f_o = output frequency in MHz; V_{CC} = supply voltage in V;

 - $\sum (C_L \times V_{CC}^2 \times f_0) =$ sum of the outputs.
- 2. The condition is $V_I = GND$ to V_{CO}

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
14-Pin Plastic DIL	–40°C to +125°C	74LV27 N	74LV27 N	SOT27-1
14-Pin Plastic SO	-40°C to +125°C	74LV27 D	74LV27 D	SOT108-1
14-Pin Plastic SSOP Type II	–40°C to +125°C	74LV27 DB	74LV27 DB	SOT337-1
14-Pin Plastic TSSOP Type I	-40°C to +125°C	74LV27 PW	74LV27PW DH	SOT402-1

PIN DESCRIPTION

PIN NUMBER SYMBOL		NAME AND FUNCTION
1, 3, 9	1A – 3A	Data inputs
2, 4, 10	1B – 3B	Data inputs
13, 5, 11	1C – 3C	Data inputs
7	GND	Ground (0 V)
12, 6, 8	1Y – 3Y	Data outputs
14	V _{CC}	Positive supply voltage

FUNCTION TABLE

	OUTPUTS		
nA	nB	nC	nY
L	L	L	Н
Х	Х	Н	L
Х	Н	Х	L
н	Х	Х	L

NOTES:

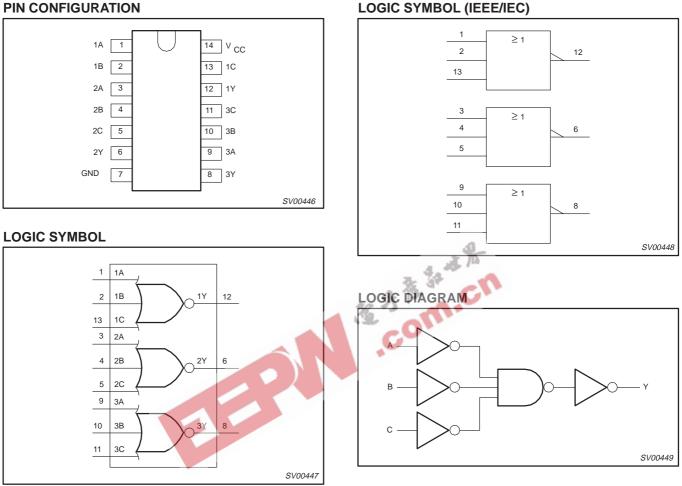
H = HIGH voltage level

L = LOW voltage level

X = don't care

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PIN CONFIGURATION



RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNIT
V _{CC}	DC supply voltage	See Note 1	1.0	3.3	5.5	V
VI	Input voltage		0	-	V _{CC}	V
Vo	Output voltage		0	-	V _{CC}	V
T _{amb}	Operating ambient temperature range in free air	See DC and AC characteristics	-40 -40		+85 +125	°C
t _r , t _f	Input rise and fall times	$\begin{array}{l} V_{CC} = 1.0V \mbox{ to } 2.0V \\ V_{CC} = 2.0V \mbox{ to } 2.7V \\ V_{CC} = 2.7V \mbox{ to } 3.6V \\ V_{CC} = 3.6V \mbox{ to } 5.5V \end{array}$		- - -	500 200 100 50	ns/V

NOTE:

1. The LV is guaranteed to function down to V_{CC} = 1.0V (input levels GND or V_{CC}); DC characteristics are guaranteed from V_{CC} = 1.2V to V_{CC} = 5.5V.

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ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134).

Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
$\pm I_{IK}$	DC input diode current	$V_{I} < -0.5 \text{ or } V_{I} > V_{CC} + 0.5 V$	20	mA
$\pm I_{OK}$	DC output diode current	$V_{\rm O} < -0.5 \text{ or } V_{\rm O} > V_{\rm CC} + 0.5 V$	50	mA
$\pm I_{O}$	DC output source or sink current – standard outputs	$-0.5V < V_{O} < V_{CC} + 0.5V$	25	mA
$^{\pm I_{GND},}_{\pm I_{CC}}$	DC V _{CC} or GND current for types with – standard outputs		50	mA
T _{stg}	Storage temperature range		-65 to +150	°C
P _{TOT}	Power dissipation per package – plastic DIL – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

NOTES:
1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V)

			LIMITS						
SYMBOL	PARAMETER	TEST CONDITIONS	-40	°C to +8	5°C	-40°C to	o +125°C	UNIT	
			MIN	TYP ¹	MAX	MIN	MAX	1	
	1	$V_{CC} = 1.2V$	0.9			0.9			
VIH	HIGH level Input	$V_{CC} = 2.0V$	1.4			1.4		V	
VIН	voltage	$V_{CC} = 2.7$ to 3.6V	2.0			2.0] `	
		$V_{CC} = 4.5$ to 5.5V	0.7 * V _{CC}			0.7 * V _{CC}			
		$V_{CC} = 1.2V$			0.3		0.3		
VIL	LOW level Input	$V_{CC} = 2.0V$			0.6		0.6	V	
۷IL	voltage	V _{CC} = 2.7 to 3.6V			0.8		0.8] `	
		$V_{CC} = 4.5$ to 5.5			0.3 * V _{CC}		0.3 * V _{CC}		
, HIGH level output	$V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$		1.2						
	V_{CC} = 2.0V; V_I = V_{IH} or V_{IL} ; $-I_O$ = 100 μ A	1.8	2.0		1.8]		
V _{OH}	voltage; all outputs	V_{CC} = 2.7V; V_I = V_{IH} or $V_{IL;}$ – I_O = 100 μ A	2.5	2.7		2.5		V	
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	2.8	3.0		2.8			
		V_{CC} = 4.5V; V_I = V_{IH} or V_{IL} ; $-I_O$ = 100 μ A	4.3	4.5		4.3			
V _{он}	HIGH level output voltage;	V_{CC} = 3.0V; V_I = V_{IH} or V_{IL} , $-I_O$ = 6mA	2.40	2.82		2.20		v	
*OH	STANDARD outputs	V_{CC} = 4.5V; V_{I} = V_{IH} or V_{IL} , $-I_{O}$ = 12mA	3.60	4.20		3.50			
		V_{CC} = 1.2V; V_I = V_{IH} or $V_{IL;} I_O$ = 100 μ A		0					
	LOW level output	V_{CC} = 2.0V; V_I = V_{IH} or $V_{IL;} I_O$ = 100 μ A		0	0.2		0.2		
V _{OL}	voltage; all outputs	V_{CC} = 2.7V; V_I = V_{IH} or $V_{IL;} I_O$ = 100 μ A		0	0.2		0.2	V	
		V_{CC} = 3.0V; V_I = V_{IH} or $V_{IL;} I_O$ = 100 μ A		0	0.2		0.2		
		V_{CC} = 4.5V; V_I = V_{IH} or $V_{IL;} I_O$ = 100 μ A		0	0.2		0.2		
VOL		V_{CC} = 3.0V; V_{I} = V_{IH} or V_{IL} ; I_{O} = 6mA		0.25	0.40		0.50	v	
0	STANDARD outputs	V_{CC} = 4.5V; V_{I} = V_{IH} or V_{IL} ; I_{O} = 12mA		0.35	0.55		0.65		
Ιį	Input leakage current	V_{CC} = 5.5V; V_I = V_{CC} or GND			1.0		1.0	μA	

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DC ELECTRICAL CHARACTERISTICS (Continued)

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

			LIMITS						
SYMBOL	PARAMETER	TEST CONDITIONS	-40	°C to +8	5°C	-40°C to	UNIT		
			MIN	TYP ¹	MAX	MIN	MAX		
Icc	Quiescent supply current; SSI	V_{CC} = 5.5V; V_{I} = V_{CC} or GND; I_{O} = 0			20.0		40	μΑ	
ΔI _{CC}	Additional quiescent supply current	$V_{CC} = 2.7V$ to 3.6V; $V_{I} = V_{CC} - 0.6V$			500		850	μΑ	

NOTE:

1. All typical values are measured at T_{amb} = 25°C.

AC CHARACTERISTICS

GND = 0V; $t_r = t_f \le 2.5ns$; $C_L = 50pF$; $R_L = 1K\Omega$

		CONDITION						
SYMBOL	PARAMETER	WAVEFORM	CONDITION	–40 to +85 °	С	–40 to +125 °C	UNIT	
			V _{CC} (V)	MIN TYP ¹	MAX	MIN MAX	1	
		Propagation delay nA, nB, nC to nY Figures 1, 2	1.2	50				
	Deep south a shale of		2.0	17	22	27		
t _{PHL/PLH}	nA, nB, nC to nY		2.7	13	16	20	ns	
	,,		3.0 to 3.6	10 ²	13	16		
			4.5 to 5.5		11	14		

NOTES:

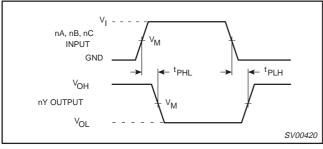
1. Unless otherwise stated, all typical values are measured at Tamb = 25°C

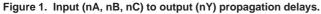
2. Typical values are measured at $V_{CC} = 3.3$ V.

AC WAVEFORMS

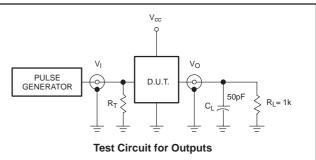
 V_{M} = 1.5 V at $V_{CC} \ge 2.7$ V and ≤ 3.6 V;

 $V_M^{}=0.5\times V_{CC}$ at $V_{CC}<2.7$ V and ≥4.5 V; V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.





TEST CIRCUIT



DEFINITIONS

 R_L = Load resistor C_L = Load capacitance includes jig and probe capacitiance

 R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.

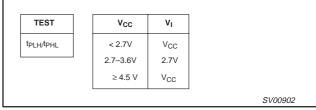
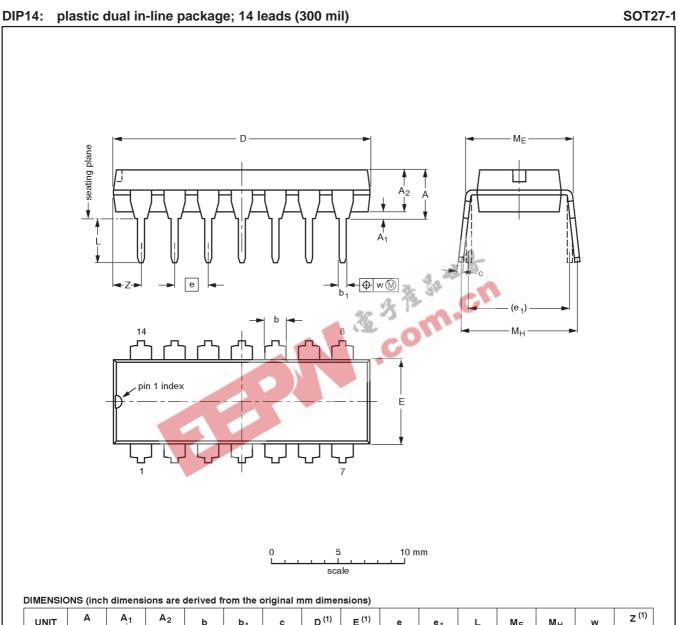


Figure 2. Load circuitry for switching times.

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Α \mathbf{A}_1 Α2 b₁ c D⁽¹⁾ E⁽¹⁾ UNIT b е ~

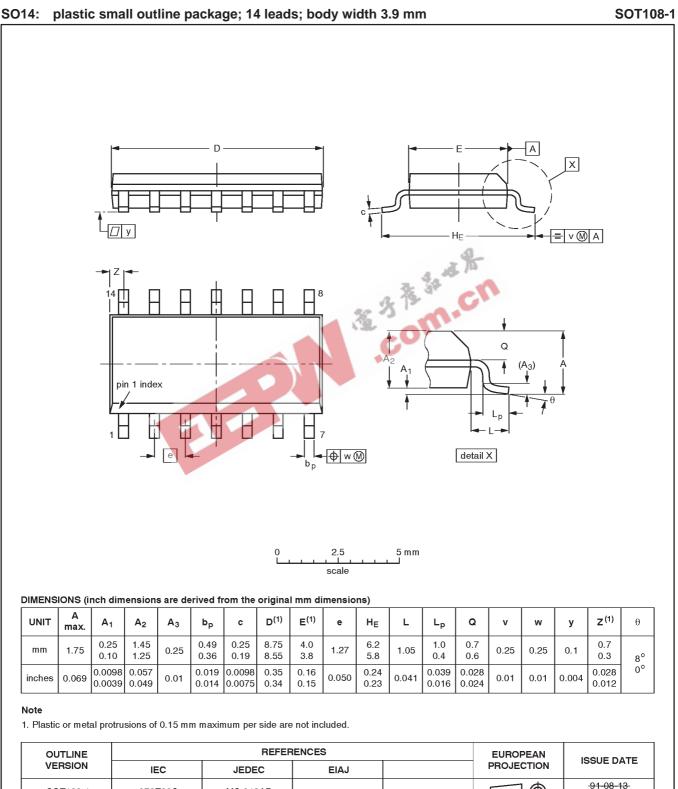
UNIT	max.	min.	max.	b	P1	C	0.7	EY	e	e ₁	Ŀ	IVIE	мн	vv	max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES EUROPEAN						
VERSION	IEC	JEDEC	EIAJ		PROJECTION ISSUE DATE		
SOT27-1	050G04	MO-001AA				-92-11-17 95-03-11	

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SO14:

SOT108-1

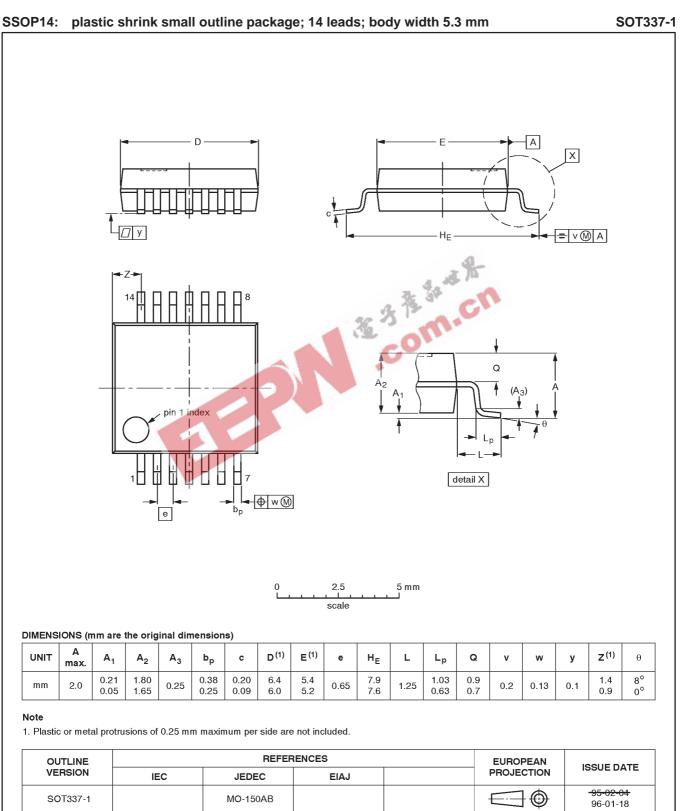
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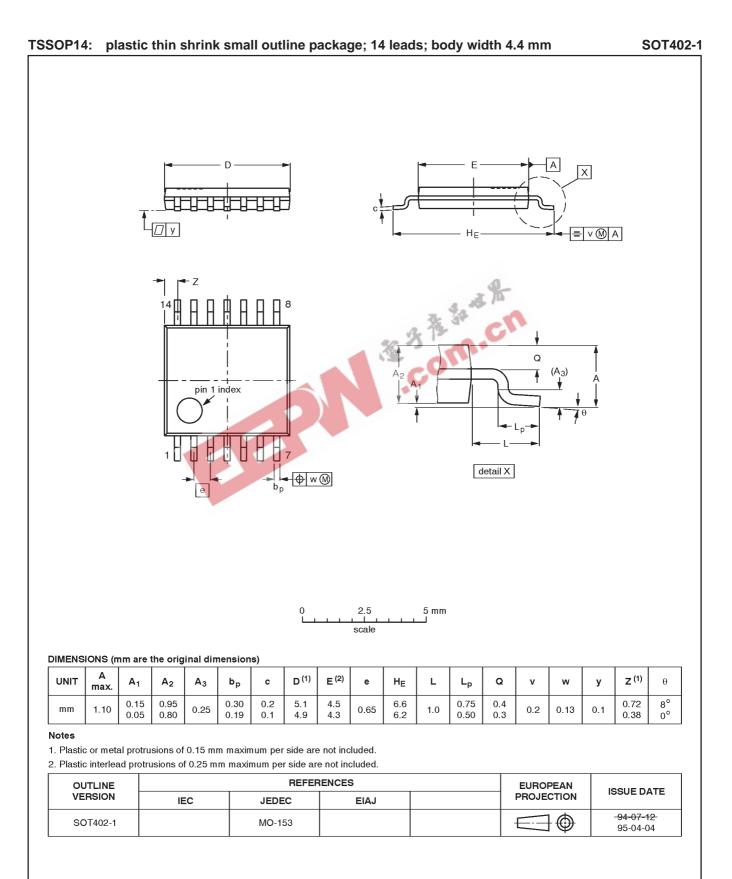
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Product specification

74LV27





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		DEFINITIONS
Data Sheet Identification	Product Status	Definition
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
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